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March 2010

# FDS6930B Dual N-Channel Logic Level PowerTrench<sup>®</sup> MOSFET

### Features

■ 5.5 A, 30 V.  $R_{DS(ON)} = 38 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ 

 $R_{DS(ON)} = 50 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$ 

- Fast switching speedLow gate charge
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- High power and current handling capability

## **General Description**

These N-Channel Logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.



## Absolute Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V <sub>DSS</sub>	Drain-Source Voltage		30	V
V <sub>GSS</sub>	Gate-Source Voltage		± 20	V
I <sub>D</sub>	Drain Current – Continuous	(Note 1a)	5.5	A
	- Pulsed		20	
P <sub>D</sub>	Power Dissipation for Dual Operation (Note 1)		2	W
	Power Dissipation for Single Operation (Note 1a)		1.6	
		(Note 1b)	1	
		(Note 1c)	0.9	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		–55 to 150	°C
Thermal Cha	racteristics			•
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient (Note 1a)		78	°C/W
R <sub>0JC</sub>	Thermal Resistance, Junction-to-Case (Note		40	°C/W

# Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6930B	FDS6930B	13"	12mm	2500 units

FDS6930B
Dual N
N-Channel
Logic
Level
N-Channel Logic Level PowerTrench <sup>®</sup> I
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Charac	teristics					•
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		26		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$ $V_{DS} = 24 V, V_{GS} = 0 V, T_J = 55^{\circ}C$			1 10	μA
I <sub>GSS</sub>	Gate-Source Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Charact	teristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-4.6		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A} \\ V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 4.8 \text{ A} \\ V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C} \end{array} $		31 40 45	38 50 62	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	20			A
9fs	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 5.5 A$		19		S
Dynamic C	haracteristics		-			
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		310	412	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		90	120	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			40	60	pF
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = 15 mV, f = 1.0 MHz		1.9		Ω
Switching (	Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 1 \text{ A},$		6	12	ns
t <sub>r</sub>	Turn–On Rise Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		6	12	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			16	28	ns
t <sub>f</sub>	Turn–Off Fall Time			2	4	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 5.5 A,		2.7	3.8	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 5 V$		1.0		nC
Q <sub>gd</sub>	Gate-Drain Charge			0.7		nC
Drain-Sou	rce Diode Characteristics and Maximun	Ratings		1		
I <sub>S</sub>	Maximum Continuous Drain-Source Did	ode Forward Current			1.3	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 1.3 \text{ A} \text{ (Note 2)}$		0.8	1.2	V
t <sub>rr</sub>	Diode Reverse Recovery Time (note3)	I <sub>F</sub> = 5.5 A, d <sub>iF</sub> /d <sub>t</sub> = 100 A/μs		16	32	nS
Q <sub>rr</sub>	Diode Reverse Recovery Charge			6		nC

Notes:

R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>BJC</sub> is guaranteed by design while R<sub>BCA</sub> is determined by the user's board design.



a) 78°C/W when mounted on a 0.5 in<sup>2</sup> pad of 2 oz copper



b) 125°C/W when mounted on a 0.02 in<sup>2</sup> pad of 2 oz copper

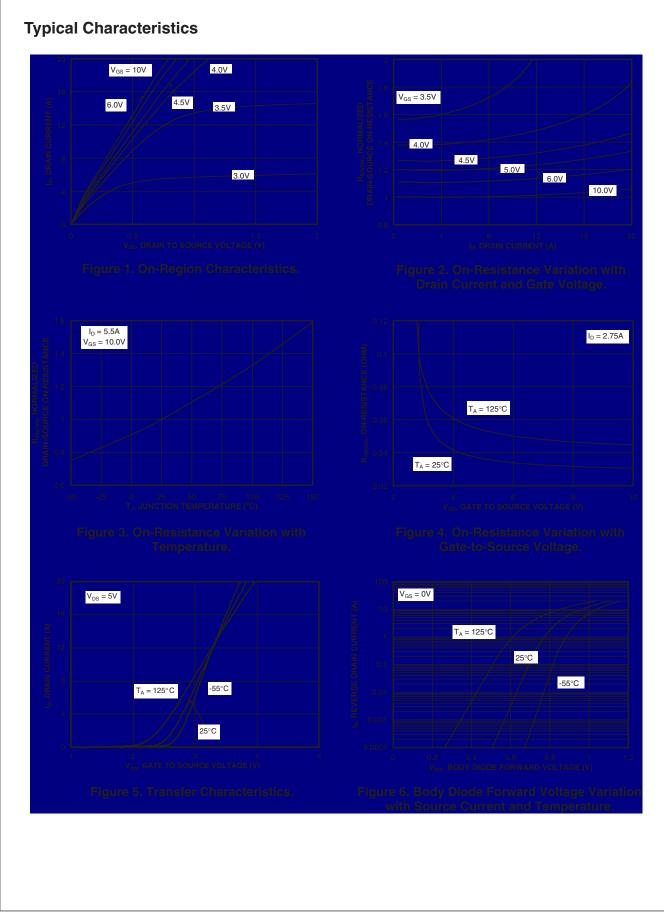
c) 135°C/W when mounted on a minimum pad. 

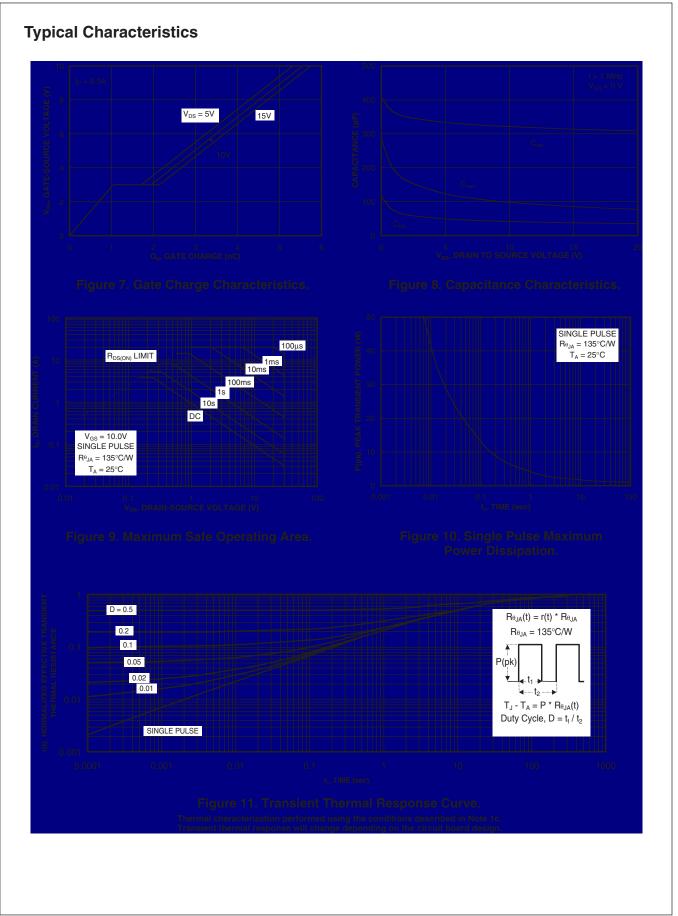
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Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

3. Trr parameter will not be subjected to 100% production testing.





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Demition of Terms			
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